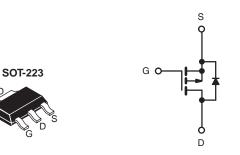


## NDT452AP-NL-VB Datasheet

# P-Channel 35V (D-S) MOSFET

PRODU	CT SUMMARY			
V <sub>DS</sub> (V)	$R_{DS(on)}(\Omega)$	I <sub>D</sub> (A) <sup>d</sup>	Q <sub>g</sub> (Typ.)	
- 35	$0.040$ at $V_{GS} = -10 \text{ V}$	- 6.2	9.8 nC	
- 35	0.048 at V <sub>GS</sub> = - 4.5 V	- 5.1	9.0110	



P-Channel MOSFET

#### **FEATURES**

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFET
- 100 % R<sub>g</sub> Tested
- 100 % UIS Tested
- Compliant to RoHS Directive 2002/95/EC

#### **APPLICATIONS**

- Load Switches, Adaptor Switch
  - Notebook PCs



ROHS COMPLIANT HALOGEN FREE

ABSOLUTE MAXIMUM RATINGS	$T_A = 25 ^{\circ}\text{C}$ , unless oth	erwise noted)		
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V <sub>DS</sub>	- 35	V	
Gate-Source Voltage		V <sub>GS</sub>	± 20	V  , b , b  mJ  W
Continuous Dusin Courset /T 450 90)	T <sub>C</sub> = 25 °C		- 6.2	
	T <sub>C</sub> = 70 °C		- 4.8	
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	- 4.5 <sup>a, b</sup>	
	T <sub>A</sub> = 70 °C		- 3.4 <sup>a, b</sup>	
Pulsed Drain Current		I <sub>DM</sub>	- 20	A
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C		- 3.5	
	T <sub>A</sub> = 25 °C	I <sub>S</sub>	- 2.1 <sup>a, b</sup>	
Avalanche Current	1 0.1 ml l	I <sub>AS</sub>	- 10	
Single-Pulse Avalanche Energy	L = 0.1 mH	E <sub>AS</sub>	5	mJ
	T <sub>C</sub> = 25 °C		4.2	
M	T <sub>C</sub> = 70 °C		2.7	14/
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2.5 <sup>a, b</sup>	VV
	T <sub>A</sub> = 70 °C		1.6 <sup>a, b</sup>	
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient <sup>a, c</sup>	t ≤ 10 s	R <sub>thJA</sub>	40	50	°C/W
Maximum Junction-to-Foot	Steady State	R <sub>thJF</sub>	24	30	C/VV

#### Notes:

- a. Surface mounted on 1" x 1" FR4 board.
- b. t = 10 s.
- c. Maximum under steady state conditions is 85  $^{\circ}\text{C/W}.$
- d. Based on  $T_C$  = 25 °C.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static				•		,
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 35			V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$			- 42		m\//º(
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = - 250 μA		4.6		mv/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 0.6		- 1.8	V
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
Zawa Cata Valtaria Dunin Communi		V <sub>DS</sub> = - 35 V, V <sub>GS</sub> = 0 V			- 1	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = - 35 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C			- 5	μA A Ω S PF
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge -10 \text{ V}, V_{GS} = -10 \text{ V}$	- 10			Α
Dunin Course On Chata Desistance		V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 5 A		0.040		
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 4 A		0.048		Ω
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 10 V, I <sub>D</sub> = - 5 A		14		S
Dynamic <sup>b</sup>						
Input Capacitance	C <sub>iss</sub>			970		
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = - 20 V, V <sub>GS</sub> = 0 V, f = 1 MHz		120		V mV/°C V nA μA A Ω S pF
Reverse Transfer Capacitance	C <sub>rss</sub>			95		
T. 10 . 0		V <sub>DS</sub> = - 20 V, V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 5 A		23	35	
Total Gate Charge	Q <sub>g</sub>		9.8	16		
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> = - 20 V, V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 5 A		3		nC
Gate-Drain Charge	Q <sub>gd</sub>			5.2		
Gate Resistance	R <sub>g</sub>	f = 1 MHz	1.0	5.5	11	Ω
Turn-On Delay Time	t <sub>d(on)</sub>			7	14	
Rise Time	t <sub>r</sub>	$V_{DD} = -20 \text{ V, R}_{1} = 4 \Omega$		12	24	
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong -5 \text{ A}, V_{GEN} = -10 \text{ V}, R_g = 1 \Omega$		30	60	
Fall Time	t <sub>f</sub>			9	18	
Turn-On Delay Time	t <sub>d(on)</sub>			44	80	ns
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 20 V, $R_L$ = 4 $\Omega$		33	60	
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong -5 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_g = 1 \Omega$		28	55	
Fall Time	t <sub>f</sub>			13	25	
Drain-Source Body Diode Characterist	tics			•		,
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			- 3.5	
Pulse Diode Forward Current	I <sub>SM</sub>				- 20	A
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = - 2 A, V <sub>GS</sub> = 0 V		- 0.76	- 1.2	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>			27	50	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			19	35	nC
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = -2 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 °\text{C}$		14	7 50 ns 9 35 nC	
Reverse Recovery Rise Time	t <sub>b</sub>			13		ns

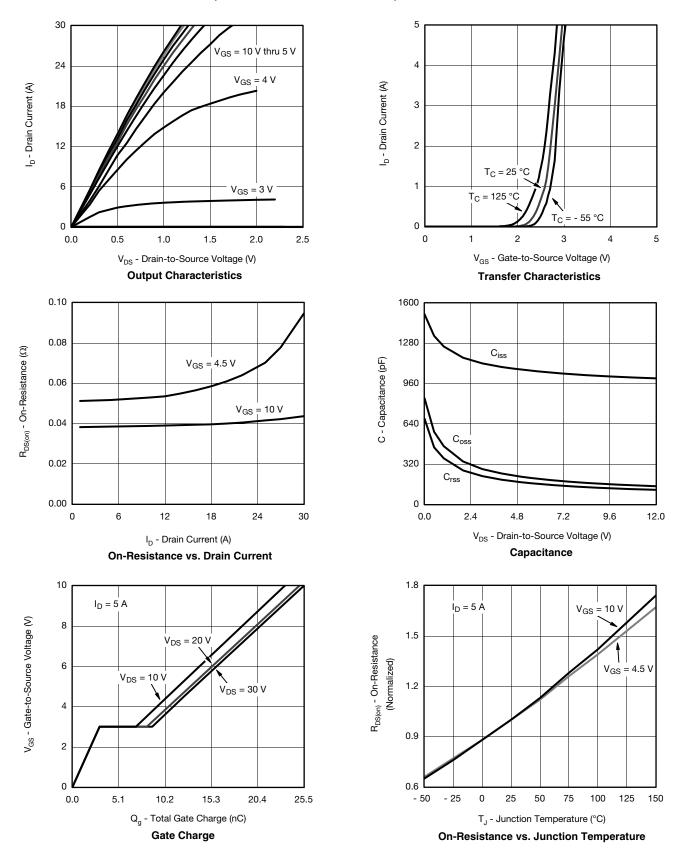
#### Notes:

- a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

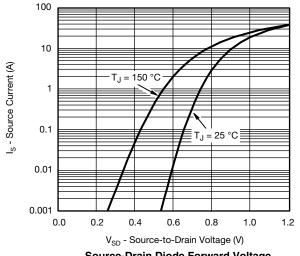
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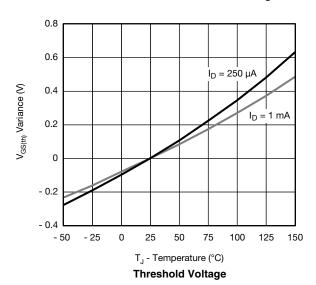


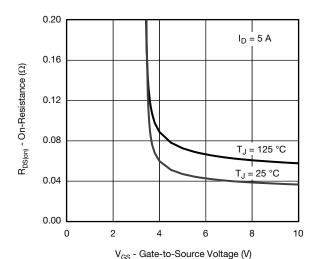
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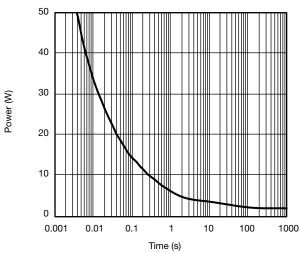


#### Source-Drain Diode Forward Voltage

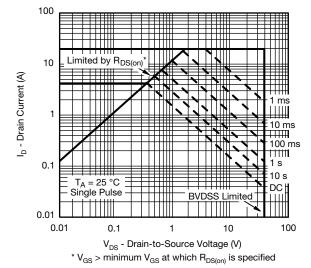




On-Resistance vs. Gate-to-Source Voltage

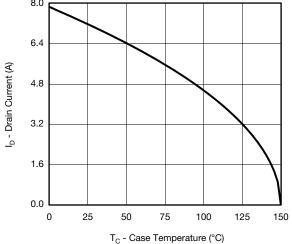


Single Pulse Power, Junction-to-Ambient

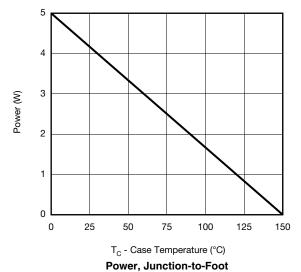


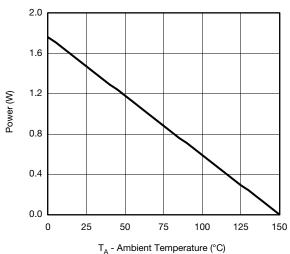
Safe Operating Area





**Current Derating\*** 



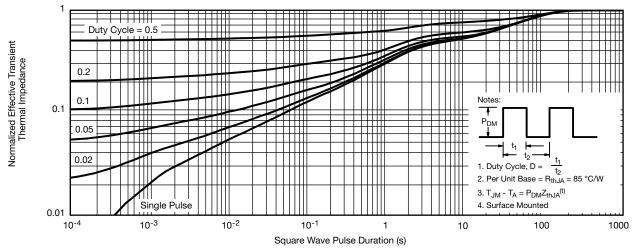


**Power Derating, Junction-to-Ambient** 

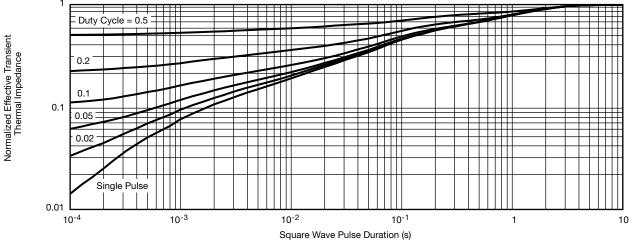
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 $<sup>^*</sup>$  The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





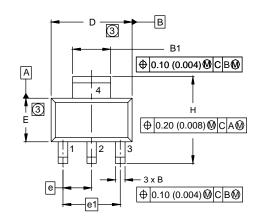
Normalized Thermal Transient Impedance, Junction-to-Ambient

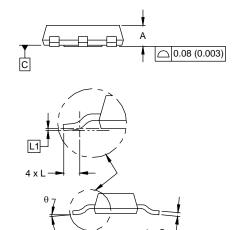


Normalized Thermal Transient Impedance, Junction-to-Foot



### **SOT-223 (HIGH VOLTAGE)**





DIM.	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
Α	1.55	1.80	0.061	0.071
В	0.65	0.85	0.026	0.033
B1	2.95	3.15	0.116	0.124
С	0.25	0.35	0.010	0.014
D	6.30	6.70	0.248	0.264
E	3.30	3.70	0.130	0.146
е	2.30	BSC	0.090	5 BSC
e1	4.60	BSC	0.181	BSC
Н	6.71	7.29	0.264	0.287
L	0.91	-	0.036	-
L1	0.061 BSC		0.002	4 BSC
θ	-	10'	-	10'

ECN: S-82109-Rev. A, 15-Sep-08

DWG: 5969

#### Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimensions are shown in millimeters (inches).
- 3. Dimension do not include mold flash.
- 4. Outline conforms to JEDEC outline TO-261AA.

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